19-0706; Rev 1; 3/07

EVALUATION KIT AVAILABLE

2MHz High-Brightness LED Drivers with High-Side Current Sense and 5000:1 Dimming

General Description

The MAX16819/MAX16820, step-down constant-current high-brightness LED (HB LED) drivers provide a cost-effective solution for automotive interior/exterior lighting, architectural and ambient lighting, LED bulbs such as MR16 and other LED illumination applications.

The MAX16819/MAX16820 operate from a 4.5V to 28V input voltage range and feature a 5V/10mA on-board regulator. A high-side current-sense resistor adjusts the output current and a dedicated PWM input (DIM) enables a wide range of pulsed dimming.

The MAX16819/MAX16820 are well suited for applications requiring a wide input voltage range. The high-side current-sensing and an integrated current-setting circuitry minimize the number of external components while delivering an LED current with ±5% accuracy. A hysteretic control algorithm ensures excellent input-supply rejection and fast response during load transients and PWM dimming. The MAX16819 features a 30% inductor current ripple and the MAX16820 features a 10% current ripple. These devices operate up to 2MHz switching frequency, thus allowing for small component size.

The MAX16819/MAX16820 operate over the -40°C to +125°C automotive temperature range and are available in 3mm x 3mm x 0.8mm, 6-pin TDFN packages.

Applications

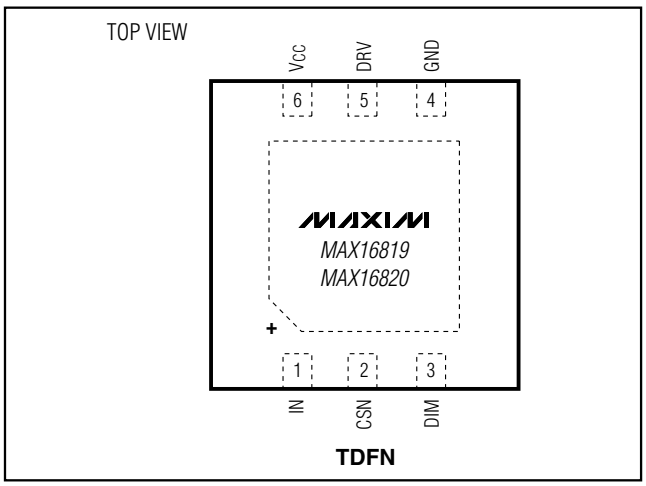
Architectural, Industrial, and Ambient Lighting

Automotive RCL, DRL, and Fog Lights

MR16 and Other LED Bulbs

Indicators and Emergency Lighting

Pin Configuration



Features

- ♦ **High-Side Current Sense**
- ♦ **Dedicated Dimming Control Input**
- ♦ **20kHz Maximum Dimming Frequency**
- ♦ **Hysteretic Control: No Compensation**
- ♦ **Up to 2MHz Switching Frequency**
- ♦ **±5% LED Current Accuracy**
- ♦ **Adjustable Constant LED Current**
- ♦ **4.5V to 28V Input Voltage Range**
- ♦ **Over 25W Output Power**
- ♦ **5V, 10mA On-Board Regulator**
- ♦ **-40°C to +125°C Operating Temperature Range**

Ordering Information

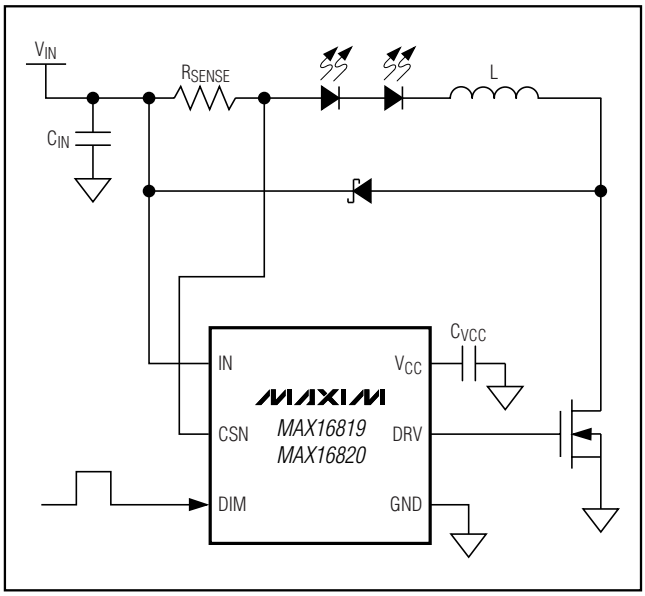
PART	PIN-PACKAGE	PKG CODE	TOP MARK
MAX16819ATT+T	6 TDFN–EP*	T633-2	+ATB
MAX16820ATT+T	6 TDFN-EP*	T633-2	+ATC

Note: *All devices are specified over the -40°C to +125°C operating temperature range.*

+Denotes lead-free package.

**EP = Exposed paddle.*

Typical Operating Circuit



For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

2MHz High-Brightness LED Drivers with High-Side Current Sense and 5000:1 Dimming

ABSOLUTE MAXIMUM RATINGS

IN, CSN, DIM to GND .....-0.3V to +30V
V_{CC}, DRV to GND .....-0.3V to +6V
CSN to IN.....-0.3V to +0.3V
Maximum Current into Any Pin
(except IN, V_{CC}, and DRV).....±20mA
Continuous Power Dissipation (T_A = +70°C)
6-Pin TDFN (derate 18.17mW/°C* above +70°C).....1454mW
Operating Temperature Range .....-40°C to +125°C
Junction Temperature.....+150°C
Storage Temperature Range .....-65°C to +150°C
Lead Temperature (soldering, 10s) .....+300°C
Pin-to-Pin ESD Ratings (HB Model).....2.5kV
*As per JEDEC51 Standard (Single-Layer Board).

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{IN} = 12V, V_{DIM} = V_{IN}, C_{VCC} = 1µF, R_{SENSE} = 0.5Ω, T_A = T_J = -40°C to +125°C, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Voltage Range	V_{IN}		4.5		28.0	V
Maximum Current Regulator Switching Frequency	f_{SW}				2	MHz
Ground Current	I_{GND}	DRV open			1.5	mA
Supply Current	I_{IN}	V_{DIM} < 0.6V			425	µA
Undervoltage Lockout	UVLO	V_{IN} = V_{CSN} = V_{DIM}, V_{IN} rising from 4V until V_{DRV} > V_{CC} - 0.5V		4.7	5.0	V
		V_{IN} = V_{CSN} = V_{DIM}, V_{IN} falling from 6V, V_{DRV} < 0.5V			4.5	
Undervoltage Lockout Hysteresis				0.5		V
SENSE COMPARATOR						
Sense Voltage Threshold High	V_{SNSHI}	(V_{IN} - V_{CSN}) rising from 0V until V_{DRV} < 0.5V (MAX16820)	195	210	225	mV
		(V_{IN} - V_{CSN}) rising from 0V until V_{DRV} < 0.5V (MAX16819)	213	230	246	
Sense Voltage Threshold Low	V_{SNSLO}	(V_{IN} - V_{CSN}) falling from 0.26V until V_{DRV} > (V_{CC} - 0.5V) (MAX16820)	176	190	204	mV
		(V_{IN} - V_{CSN}) falling from 0.26V until V_{DRV} > (V_{CC} - 0.5V) (MAX16819)	158	170	182	
Propagation Delay to Output High	t_{DPDH}	Falling edge of (V_{IN} - V_{CSN}) from 0.26V to 0V to DRV high, C_{DRV} = 1nF		82		ns
Propagation Delay to Output Low	t_{DPDL}	Rising edge of (V_{IN} - V_{CSN}) from 0V to 0.26V to DRV low, C_{DRV} = 1nF		82		ns
Current-Sense Input Current	I_{CSN}	(V_{IN} - V_{CSN}) = 200mV			1	µA
Current-Sense Threshold Hysteresis	CS_{HYS}	MAX16819		56	70	mV
		MAX16820		17	35	mV

ELECTRICAL CHARACTERISTICS (continued)

(V_{IN} = 12V, V_{DIM} = V_{IN}, C_{VCC} = 1µF, R_{SENSE} = 0.5Ω, T_A = T_J = -40°C to +125°C, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
GATE DRIVER						
Gate Driver Source Current		V_{CSN} = V_{IN}, V_{DRV} = 0.5 x V_{CC}		0.5		A
Gate Driver Sink Current		V_{CSN} = V_{IN} - 250mV, V_{DRV} = 0.5 x V_{CC}		1		A
Gate Driver Output-Voltage High	V_{OH}	I_{DRV} = 10mA	V_{CC} - 0.5			V
Gate Driver Output-Voltage Low	V_{OL}	I_{DRV} = -10mA			0.5	V
DIM INPUT						
Maximum DIM Frequency	f_{DIM}				20	kHz
DIM Input-Voltage High	V_{IH}	V_{CSN} = V_{IN}, increase DIM until V_{DRV} > (V_{CC} - 0.5V)	2.8			V
DIM Input-Voltage Low	V_{IL}	V_{CSN} = V_{IN}, decrease DIM until V_{DRV} < 0.5V			0.6	V
DIM Hysteresis	DIM_{HYS}			200		mV
DIM Turn-On Time	t_{DIMON}	DIM rising edge to V_{DRV} = 0.5 x V_{CC}, C_{DRV} = 1nF		100		ns
DIM Turn-Off Time	t_{DIMOFF}	DIM falling edge to V_{DRV} = 0.5 x V_{CC}, C_{DRV} = 1nF		100		ns
DIM Input Leakage High		V_{DIM} = V_{IN}			10	µA
DIM Input Leakage Low		V_{DIM} = 0V	-1		+1	µA
V_{CC} REGULATOR						
Regulator Output Voltage	V_{CC}	I_{VCC} = 0.1mA to 10mA, V_{IN} = 5.5V to 28V	4.5		5.5	V
		I_{VCC} = 0.1mA to 10mA, V_{IN} = 4.5V to 28V	4.0		5.5	V
Load Regulation		I_{VCC} = 0.1mA to 10mA, V_{IN} = 12V		4		Ω
Line Regulation		V_{IN} = 6V to 28V, I_{VCC} = 10mA		11		mV
Power-Supply Rejection Ratio	PSRR	V_{IN} = 12V, I_{VCC} = 5mA, f_{IN} = 10kHz		-35		dB
Current Limit	I_{LIM}	V_{IN} = 4.5V, V_{CC} = 0V		45		mA
		V_{IN} = 4.5V, V_{CC} = 4V		18		mA
Regulator Startup Time	t_{STRAT}	V_{CC} = 0 to 4.5V		350		µs

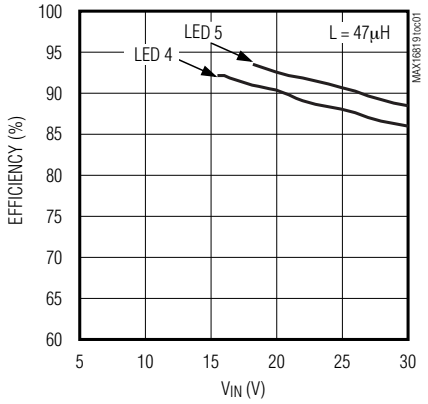
Note 1: All devices are 100% production tested at T_J = +25°C and +125°C. Limits to -40°C are guaranteed by design.

2MHz High-Brightness LED Drivers with High-Side Current Sense and 5000:1 Dimming

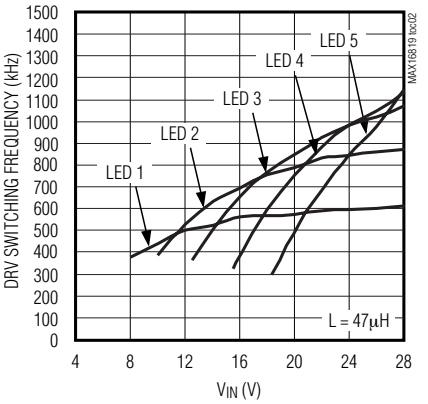
Typical Operating Characteristics

(V_{IN} = V_{DIM} = 12V, C_{VCC} = 1µF, R_{SENSE} = 0.5Ω connected between IN and CSN. Typical values at T_A = +25°C, unless otherwise noted.)

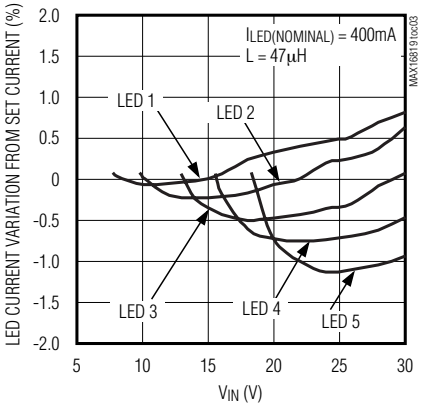
EFFICIENCY vs. V_{IN}



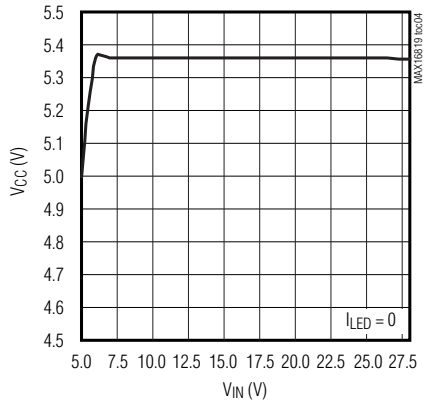
DRV SWITCHING FREQUENCY vs. V_{IN}



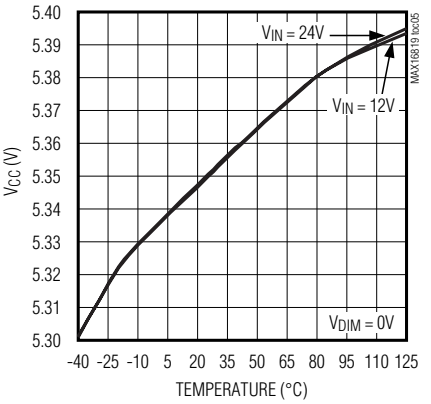
LED CURRENT VARIATION vs. V_{IN}



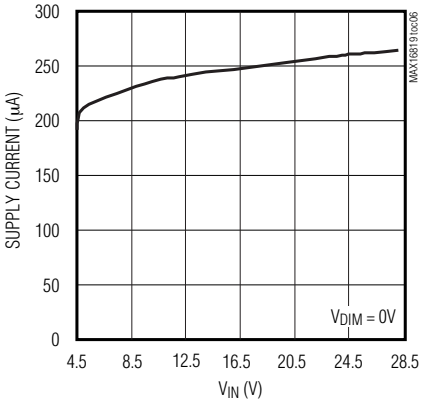
V_{CC} vs. V_{IN}



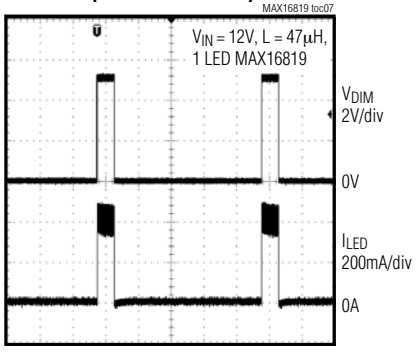
V_{CC} vs. TEMPERATURE



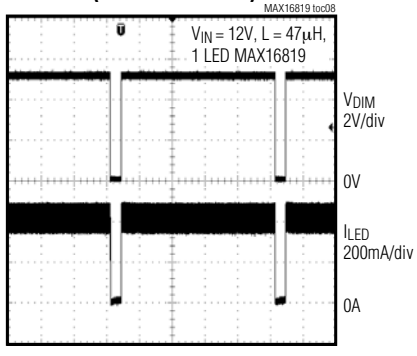
SUPPLY CURRENT vs. V_{IN}



PWM DIMMING AT 200Hz (10% DUTY CYCLE)



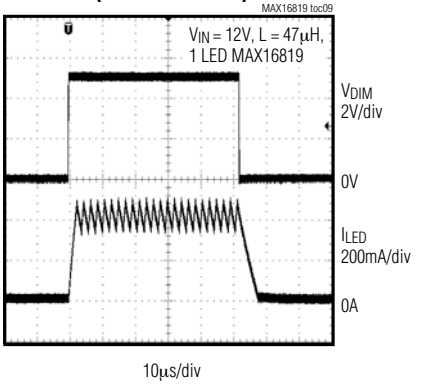
PWM DIMMING AT 200Hz (90% DUTY CYCLE)



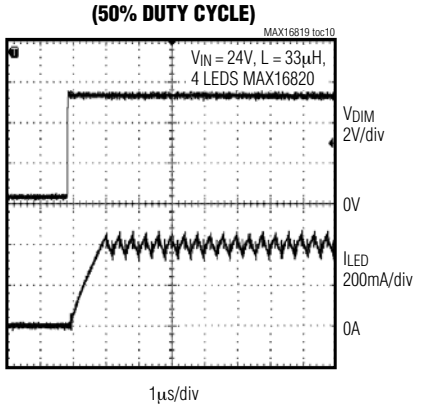
Typical Operating Characteristics (continued)

(V_{IN} = V_{DIM} = 12V, C_{VCC} = 1µF, R_{SENSE} = 0.5Ω connected between IN and CSN. Typical values at T_A = +25°C, unless otherwise noted.)

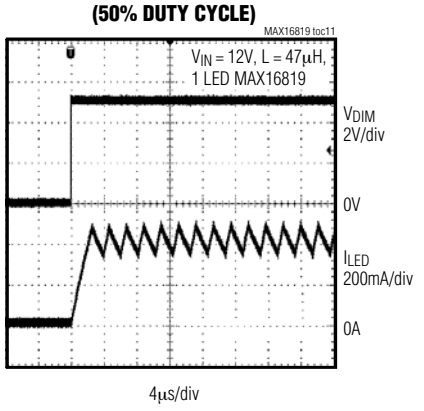
PWM DIMMING AT 200Hz (1% DUTY CYCLE)



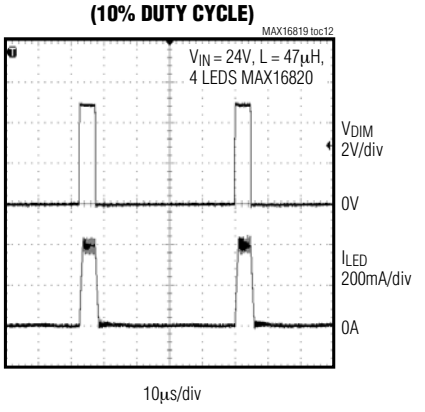
PWM DIMMING EXPANDED (50% DUTY CYCLE)



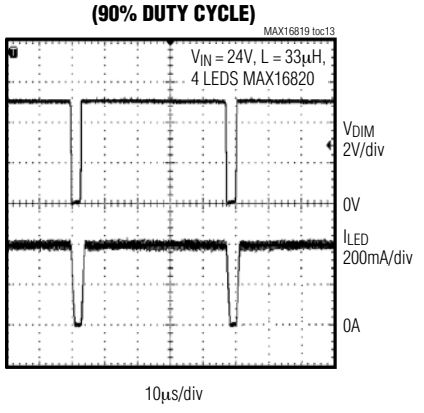
PWM DIMMING EXPANDED (50% DUTY CYCLE)



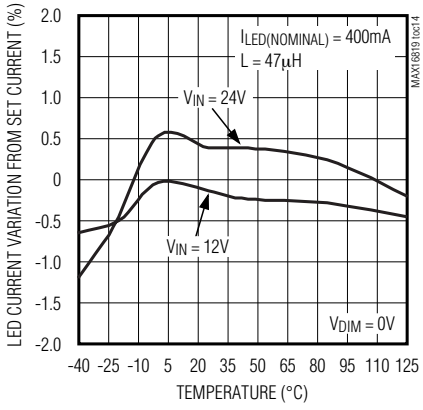
PWM DIMMING AT 20kHz (10% DUTY CYCLE)



PWM DIMMING AT 20kHz (90% DUTY CYCLE)



I_{LED} VARIATION vs. TEMPERATURE

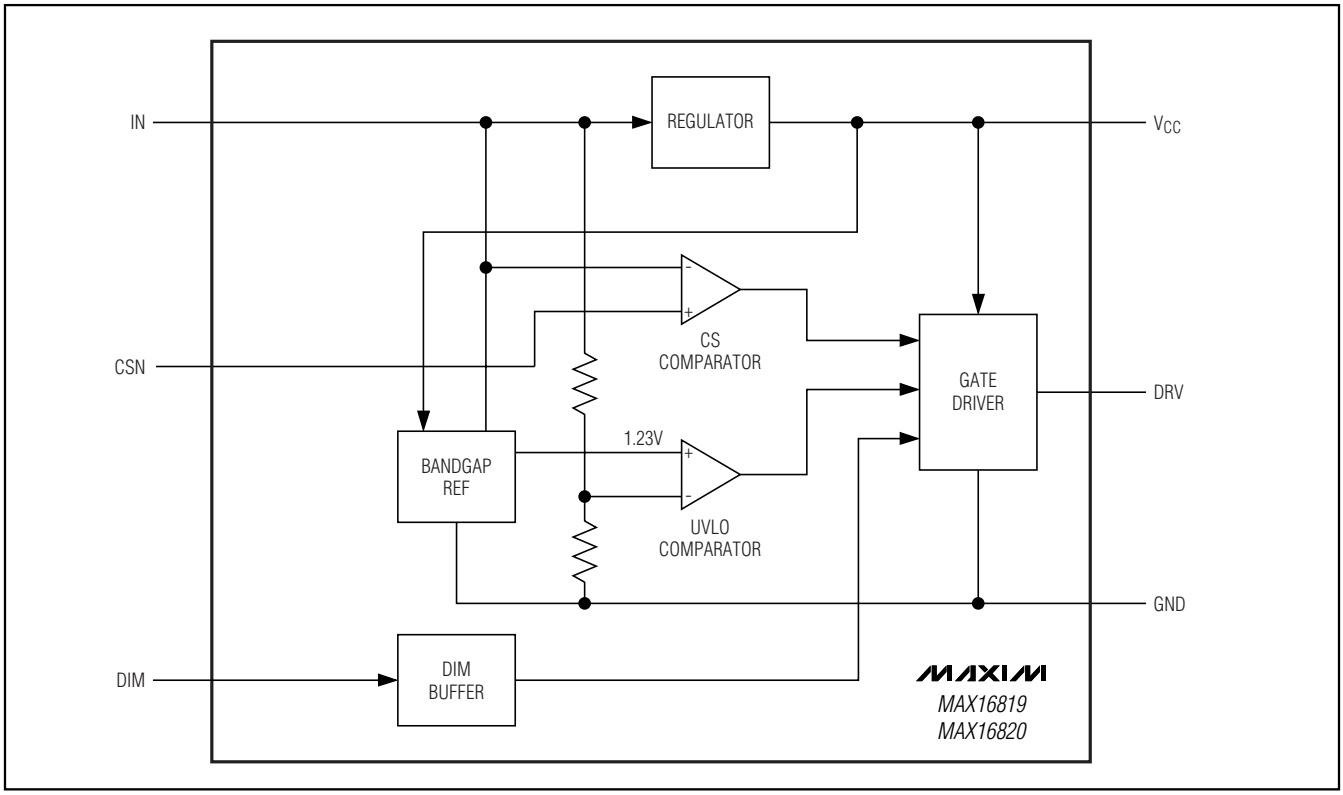


2MHz High-Brightness LED Drivers with High-Side Current Sense and 5000:1 Dimming

Pin Description

PIN	NAME	FUNCTION
1	IN	Positive Supply Voltage Input. Bypass with a 1µF or higher value capacitor to GND.
2	CSN	Current-Sense Input
3	DIM	Logic-Level Dimming Input. Drive DIM low to turn off the current regulator. Drive DIM high to enable the current regulator.
4	GND	Ground
5	DRV	Gate Drive Output. Connect to the gate of an external n-channel MOSFET.
6	V_{CC}	Voltage Regulator Output. Connect a 1µF capacitor from V_{CC} to GND.
EP	—	Exposed Paddle. Connect to a large-area ground plane for improved power dissipation. Do not use as the only ground connection for the device.

Functional Diagram



Detailed Description

The MAX16819/MAX16820 are step-down, constant-current, high-brightness LED (HB LED) drivers. These devices operate from a 4.5V to 28V input voltage range and provide up to 0.5A of source and 1A of sink drive capability to the gate of an external MOSFET. A high-side current-sense resistor sets the output current and a dedicated PWM dimming input (DIM) allows for a wide range of independent pulsed dimming.

The high-side current-sensing scheme and on-board current-setting circuitry minimize the number of external components while delivering LED current with a ±5% accuracy, using a 1% sense resistor. See the *Functional Diagram*.

Undervoltage Lockout (UVLO)

The MAX16819/MAX16820 include a 4.5V undervoltage lockout (UVLO) with 500mV hysteresis. When V_{IN} falls below 4.5V, DRV goes low, turning off the external n-channel MOSFET. DRV goes high once V_{IN} is 5V or higher.

5V Regulator

V_{CC} is the output of a 5V regulator capable of sourcing 10mA. Bypass V_{CC} to GND with a 1µF capacitor.

DIM Input

The MAX16819/MAX16820 allow dimming with a PWM signal at the DIM input. A logic level below 0.6V at DIM forces the MAX16819/MAX16820's DRV output low, turning off the LED current. To turn the LED current on, the logic level at DIM must be at least 2.8V.

Applications Information

Selecting R_{SENSE} to Set the LED Current

The MAX16819/MAX16820 feature a programmable LED current using a resistor connected between IN and CSN. Use the following equation to calculate the sense resistor:

$$R_{SENSE}(\Omega) = \frac{1}{2}\frac{(V_{SNSHI} + V_{SNSLO})(V)}{I_{LED}(A)}$$

For the values of V_{SNSHI} and V_{SNSLO}, see the *Electrical Characteristics*.

Current Regulator Operation

The MAX16819/MAX16820 regulate the LED output current using an input comparator with hysteresis (Figure 1). As the current through the inductor ramps up and the voltage across the sense resistor reaches the upper threshold, the voltage at DRV goes low, turning off the external MOSFET. The MOSFET turns on again when the inductor current ramps down through the freewheeling diode until the voltage across the sense resistor equals the lower threshold. Use the following equation to determine the operating frequency:

$$f_{SW} = \frac{(V_{IN} - n \times V_{LED}) \times n \times V_{LED} \times R_{SENSE}}{V_{IN} \times \Delta V \times L}$$

where n = number of LEDs, V_{LED} = forward voltage drop of one LED, and $\Delta V = (V_{SNSHI} - V_{SNSLO})$.

For proper component selection, please use the design tool available at: http://www.maxim-ic.com/MAX16819-20-Tool.

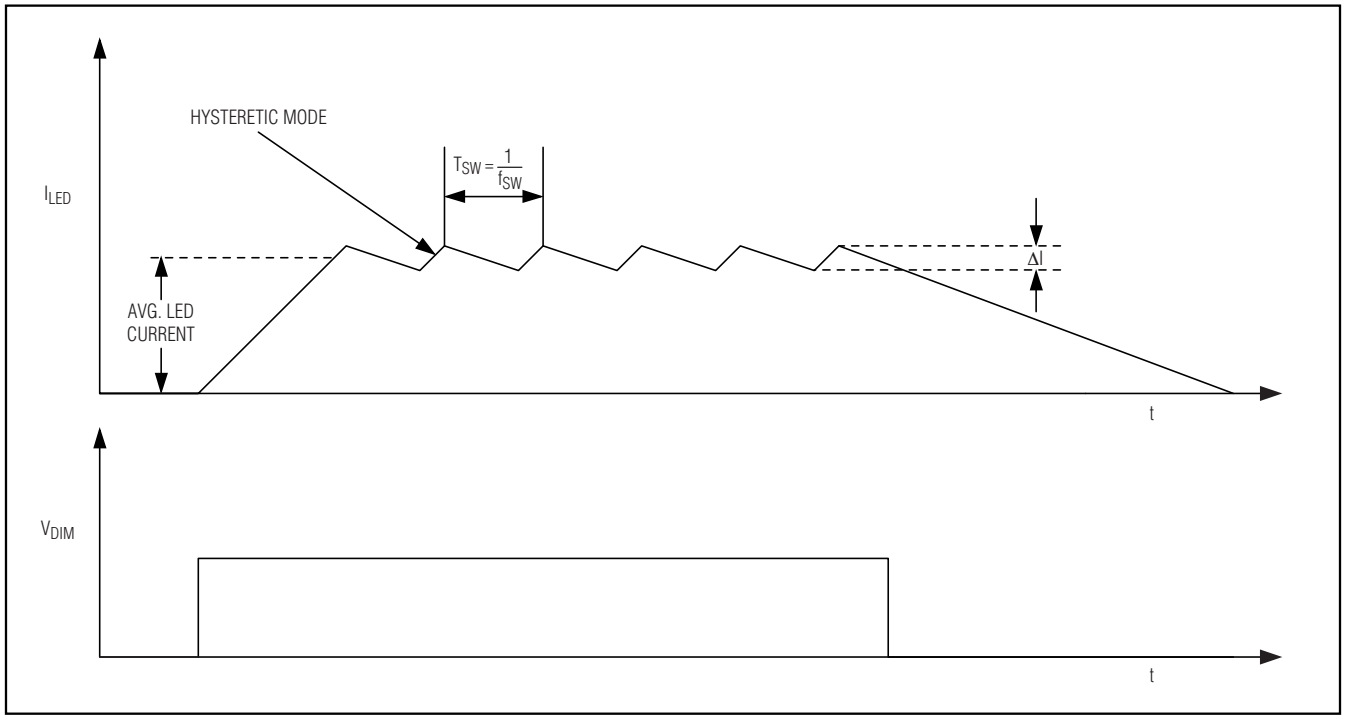


Figure 1. Current Regulator Operation

2MHz High-Brightness LED Drivers with High-Side Current Sense and 5000:1 Dimming

MOSFET Selection

The MAX16819/MAX16820's gate driver is capable of sourcing 0.5A and sinking 1A of current. MOSFET selection is based on the maximum input operating voltage V_{IN}, output current I_{LED}, and operating switching frequency. Choose a MOSFET that has a higher breakdown voltage than the maximum operation voltage, low $R_{DS(ON)}$, and low total charge for better efficiency. MOSFET threshold voltage must be adequate if operated at the low end of the input-voltage operating range.

Freewheeling Diode Selection

The forward voltage of the freewheeling diode should be as low as possible for better efficiency. A Schottky diode is a good choice as long as the breakdown voltage is high enough to withstand the maximum operating voltage.

The forward current rating of the diode must be at least equal to the maximum LED current.

LED Current Ripple

The LED current ripple is equal to the inductor current ripple. In cases when a lower LED current ripple is needed, a capacitor can be placed across the LED terminals.

PCB Layout Guidelines

Careful PCB layout is critical to achieve low switching losses and stable operation. Use a multilayer board whenever possible for better noise immunity. Minimize ground noise by connecting high-current ground returns, the input bypass-capacitor ground lead, and the output-filter ground lead to a single point (star ground configuration). In normal operation, there are two power loops. One is formed when the MOSFET is on and the high current flows through IN—R_{SENSE}—LEDs—Inductor—MOSFET—GND. The other loop is formed when the MOSFET is off when the high current circulates through R_{SENSE}—LEDs—Inductor—freewheeling diode. To minimize noise interaction, each loop area should be as small as possible.

Place R_{SENSE} as close as possible to the input filter and IN. For better noise immunity, a Kelvin connection is strongly recommended between CSN and R_{SENSE}. Connect the exposed paddle to a large-area ground plane for improved power dissipation.

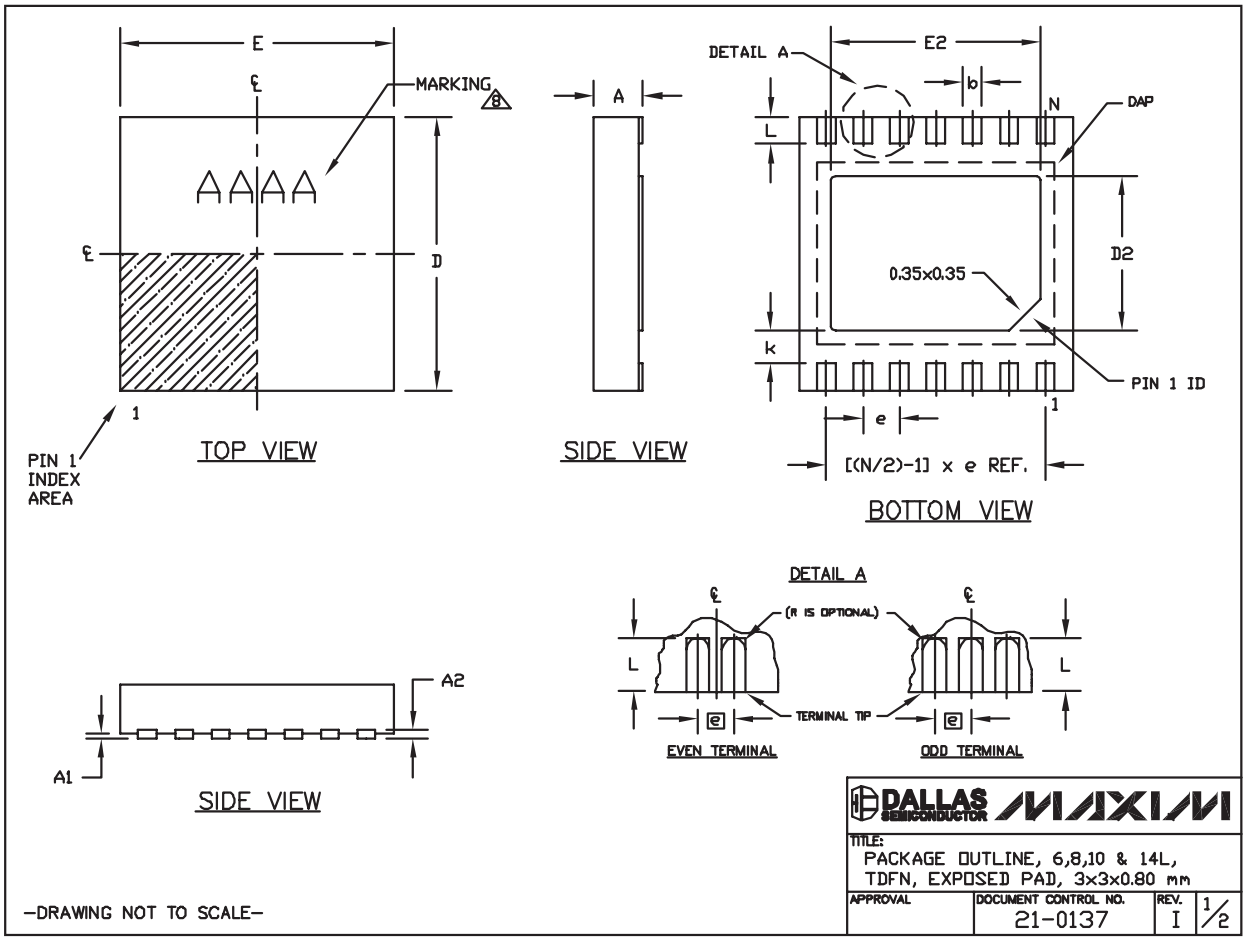
Chip Information

PROCESS: BiCMOS

2MHz High-Brightness LED Drivers with High-Side Current Sense and 5000:1 Dimming

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)



2MHz High-Brightness LED Drivers with High-Side Current Sense and 5000:1 Dimming

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)

COMMON DIMENSIONS		
SYMBOL	MIN.	MAX.
A	0.70	0.80
D	2.90	3.10
E	2.90	3.10
A1	0.00	0.05
L	0.20	0.40
k	0.25 MIN.	
A2	0.20 REF.	

PACKAGE VARIATIONS							
PKG. CODE	N	D2	E2	e	JEDEC SPEC	b	[(N/2)-1] x e
T633-2	6	1.50±0.10	2.30±0.10	0.95 BSC	MO229 / WEEA	0.40±0.05	1.90 REF
T833-2	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF
T833-3	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF
T1033-1	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF
T1033-2	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF
T1433-1	14	1.70±0.10	2.30±0.10	0.40 BSC	- - - -	0.20±0.05	2.40 REF
T1433-2	14	1.70±0.10	2.30±0.10	0.40 BSC	- - - -	0.20±0.05	2.40 REF

NOTES:
1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
2. COPLANARITY SHALL NOT EXCEED 0.08 mm.
3. WARPAGE SHALL NOT EXCEED 0.10 mm.
4. PACKAGE LENGTH/PACKAGE WIDTH ARE CONSIDERED AS SPECIAL CHARACTERISTIC(S).
5. DRAWING CONFORMS TO JEDEC MO229, EXCEPT DIMENSIONS "D2" AND "E2", AND T1433-1 & T1433-2.
6. "N" IS THE TOTAL NUMBER OF LEADS.
7. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.
8. MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.

-DRAWING NOT TO SCALE-

DALLAS SEMICONDUCTOR MAXIM

TITLE: PACKAGE OUTLINE, 6,8,10 & 14L, TDFN, EXPOSED PAD, 3x3x0.80 mm

APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0137	I	2/2

Revision History

Pages changed at Rev 1: 1, 4, 10

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MAX16819, MAX16820

2MHz High-Brightness LED Drivers with High-Side Current Sense and 5000:1 Dimming

High-Brightness Step-Down LED Driver Controllers with High-Side Current-Sensing and Rapid Current-Pulsing Capability

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Ordering Information

Notes:

1. Other options and links for purchasing parts are listed at: http://www.maxim-ic.com/sales.
2. Didn't Find What You Need? Ask our applications engineers. Expert assistance in finding parts, usually within one business day.
3. Part number suffixes: T or T&R = tape and reel; + = RoHS/lead-free; # = RoHS/lead-exempt. More: SeeFull Data Sheet or Part Naming Conventions.
4. * Some packages have variations, listed on the drawing. "PkgCode/Variation" tells which variation the product uses.

Devices: 1-4 of 4

MAX16819	Free Sample	Buy	Package: TYPE PINS FOOTPRINT DRAWING CODE/VAR *	Temp	RoHS/Lead-Free? Materials Analysis
MAX16819ATT+			THIN QFN (Dual);6 pin;10 mm Dwg: 21-0137I (PDF) Use pkgcode/variation: T633+2*	-40C to +125C	RoHS/Lead-Free: Lead Free Materials Analysis
MAX16819ATT+T			THIN QFN (Dual);6 pin;10 mm Dwg: 21-0137I (PDF) Use pkgcode/variation: T633+2*	-40C to +125C	RoHS/Lead-Free: Lead Free Materials Analysis
MAX16820	**Free Sample**	**Buy**	**Package: TYPE PINS FOOTPRINT DRAWING CODE/VAR ***	**Temp**	**RoHS/Lead-Free? Materials Analysis**
MAX16820ATT+			THIN QFN (Dual);6 pin;10 mm Dwg: 21-0137I (PDF) Use pkgcode/variation: T633+2*	-40C to +125C	RoHS/Lead-Free: Lead Free Materials Analysis
MAX16820ATT+T			THIN QFN (Dual);6 pin;10 mm Dwg: 21-0137I (PDF) Use pkgcode/variation: T633+2*	-40C to +125C	RoHS/Lead-Free: Lead Free Materials Analysis

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